

SID

Factory: Rot am See

Article:

ML8

Provided:

Customer:

Date:

03.04.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
A-RS Kupferfolie-035my 330x490mm	50200242	35	VS	 B00
C-RAS-FR4-PP-106-H71-TG150-HF-EM-37B(...)	50202996	114		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B(...)	50203000	0		
		35	L2	
C-RAS-ML-0.25-035+035-460x305-TG150HF-...	50202593	250		
		35	L3	
C-RAS-FR4-PP-106-H71-TG150-HF-EM-37B(...)	50202996	99		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B(...)	50203000	0		
		35	L4	
C-RAS-ML-0.25-035+035-460x305-TG150HF-...	50202593	250		
		35	L5	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B(...)	50203000	99		
C-RAS-FR4-PP-106-H71-TG150-HF-EM-37B(...)	50202996	0		
		35	L6	
C-RAS-ML-0.25-035+035-460x305-TG150HF-...	50202593	250		
		35	L7	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B(...)	50203000	114		
C-RAS-FR4-PP-106-H71-TG150-HF-EM-37B(...)	50202996	0		
A-RS Kupferfolie-035my 330x490mm	50200242	35	RS	

Thickness after Pressing

B00:

1440 µm

Tol+:

155 µm

Tol-:

155 µm

Dmax:

1595 µm

Dmin:

1285 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

1550 µm

Tol+:

155 µm

Tol-:

155 µm

Dmax:

1705 µm

Dmin:

1395 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

1456 µm

Version 1.2.20.35

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